

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4300777

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YOUJUN XIONG	02/13/2017
WENQUAN SHU	02/13/2017
WENHUA YU	02/13/2017
QI ZHAO	02/13/2017
YOUPENG LI	02/13/2017
RECEIVING PARTY DATA	
Name:	UBTECH ROBOTICS CORP.
Street Address:	16TH AND 22ND FLOOR, BLOCK C1, NANSHAN I PARK
Internal Address:	NO. 1001 XUEYUAN ROAD, NANSHAN DISTRICT
City:	SHENZHEN
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15448479
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	2017UBH-A1US001
NAME OF SUBMITTER:	RAYMOND J. CHEW
SIGNATURE:	/RAYMOND J. CHEW/
DATE SIGNED:	03/02/2017
Total Attachments: 2	
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ASSIGNMENT

WHEREAS Youjun Xiong; Wenquan Shu; Wenhua Yu; Qi Zhao; Youpeng Li, the assignors, whose mailing address is/are 16th and 22nd Floor, Block C1, Nanshan I Park, No. 1001 Xueyuan Road, Nanshan District, Shenzhen, Guangdong, China,

have invented certain new and useful improvements in an invention relating to and entitled ROBOT HEAD ROTATING STRUCTURE, the invention, as fully set forth and described in an application for Letters Patent to be filed at the United States Patent and Trademark Office and naming the assignors as inventors and applicants;

AND WHEREAS UBTECH Robotics Corp. of China, the assignee, whose mailing address is 16th and 22nd Floor, Block C1, Nanshan I Park, No. 1001 Xueyuan Road, Nanshan District, Shenzhen, Guangdong, China,

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to Any Letters Patent that may be obtained therefor;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, receipt of which is hereby acknowledged, the assignors, do hereby confirm that they have sold, assigned and transferred, and do hereby sell, assign and transfer to the assignee the full and exclusive right to the said invention in the United States and their entire right, title and interest for the United States in and to the invention, together with their entire right, title and interest in and to said application, any and all divisional applications thereof, and any and all Letters Patent of the United States which may issue or be reissued for the invention;

AND the assignors hereby authorize and request the Director of the United States Patent and Trademark Office to issue to said assignee of any and all said Letters Patent not already issued as the assignee of their entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by the assignors had this assignment and sale not been made.

AND the assignors, on behalf of themselves and their executors and administrators, hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent of the United States for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

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Cont.: Assignment

Youjun Xiong [Signature of Inventor], SIGNED on this [13] day of [February], 2017
Youjun Xiong

Wenquan Shu [Signature of Inventor], SIGNED on this [13] day of [February], 2017
Wenquan Shu

Wenhua Yu [Signature of Inventor], SIGNED on this [13] day of [February], 2017
Wenhua Yu

Qi Zhao [Signature of Inventor], SIGNED on this [13] day of [February], 2017
Qi Zhao

Youpeng Li [Signature of Inventor], SIGNED on this [13] day of [February], 2017
Youpeng Li

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